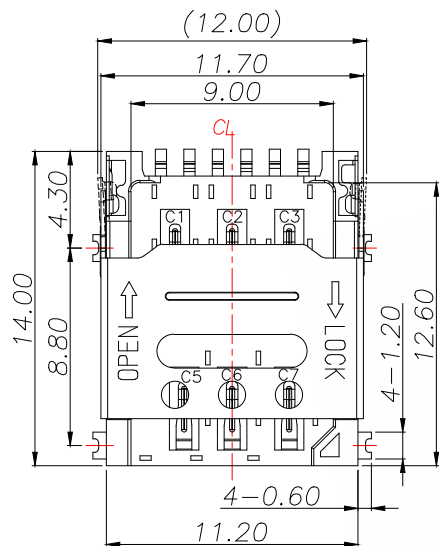
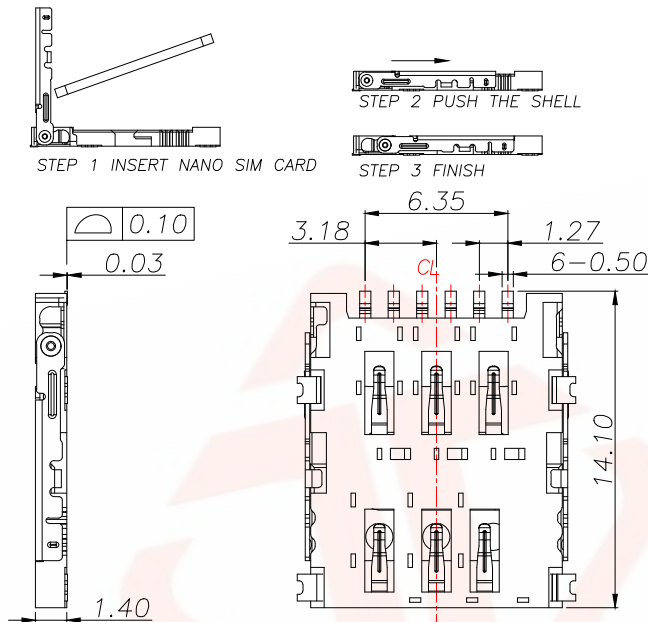
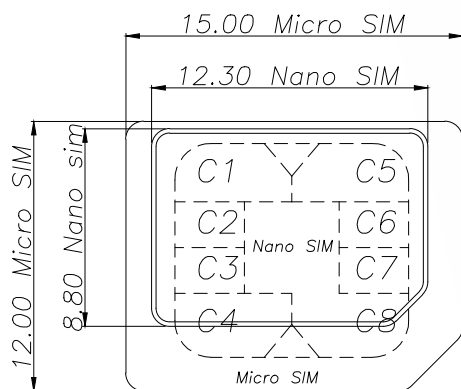
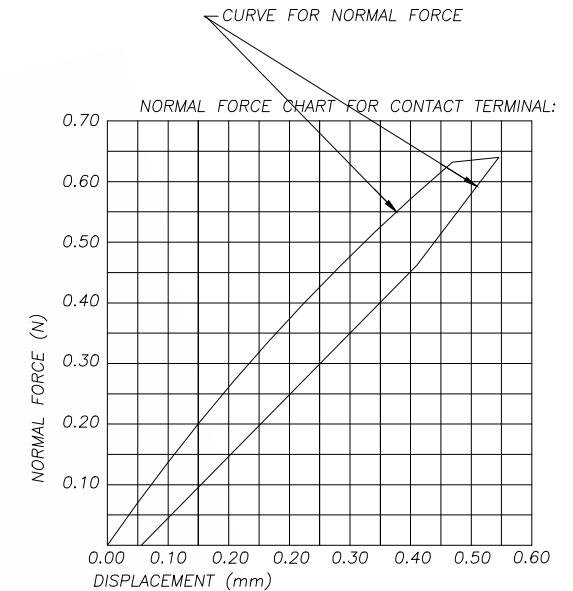


NANO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A



REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



NOTES:

1. MATERIAL:

- 1.1 Housing: High Temperature Thermoplastic UL94V-0; Color Black.
- 1.2 Terminal: Copper Alloy, T=0.12mm.
- 1.3 Shell: Stainless Steel, T=0.20mm.

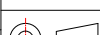
2. FINISH:

- 2.1 Terminal: Plated Gold on The Contact Area and Solder Tails
- 2.2 Peg: Plated Gold on the Solder Tails.

3. SPECIALITY:

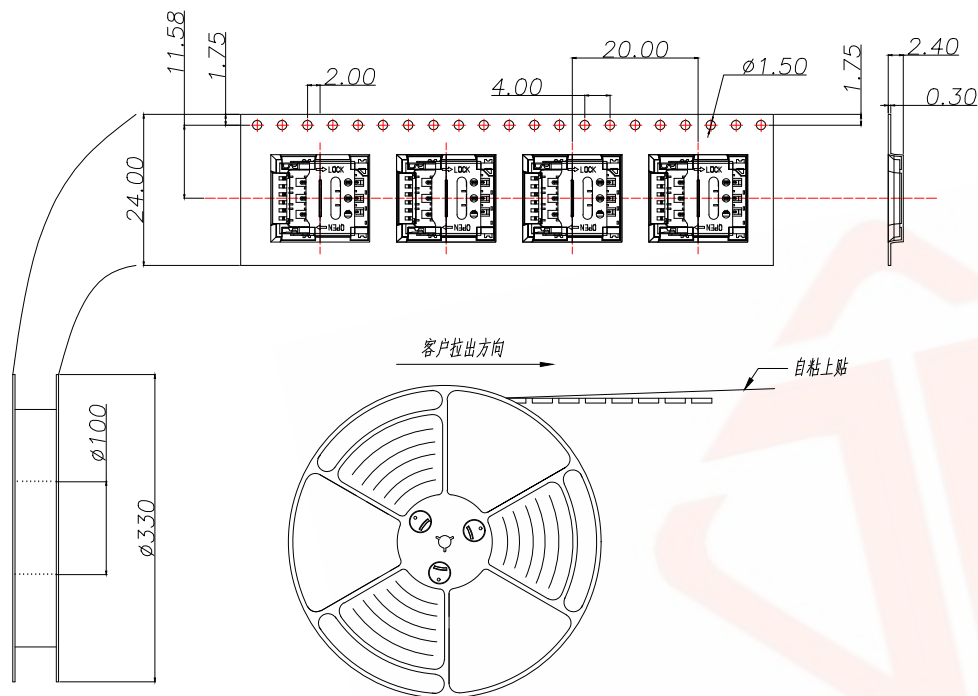
- 3.1 Rated current: 0.5A
- 3.2 Rated voltage: 50V
- 3.3 Contact Resistance: 80mQMAX
- 3.4 Insulation Resistance: 100MΩMIN 100V DC
- 3.5 Dielectric withstanding voltage: 100V AC.
- 3.6 Solder ability: 245±5°C, 5±0.5s.
- 3.7 Operating condition: Temperature: -30°C~+80°C Humidity: 80% R.H MAX

③	TERMINAL	6	C5210-EH, T=0.12	Au 3u" PLATING
②	BASE INSULATOR	1	LCP+GF30%	BLACK
①	SHELL	1	SUS304-H, T=0.15	AU/Ni PLATING
NO.	PART NAME	Q'TY	DESCRIPTION	NOTE

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
X.:±0.50	X':±2"	PART NO. CSIM-1306-6P	TITLE: 6PIN 1.4H HINGE NANO SIM CARD CONN.		
X.X:±0.20	X.X':±1"				
X.XX:±0.10					
UNITS	mm	DESIGN: Ethan	MANUFACTURE DWG 		
MATERILA	— — —	CHED: Olvia			
FINISH	— — —	APPD: Ava			
			SCALE N:A	SHEET 1/1	

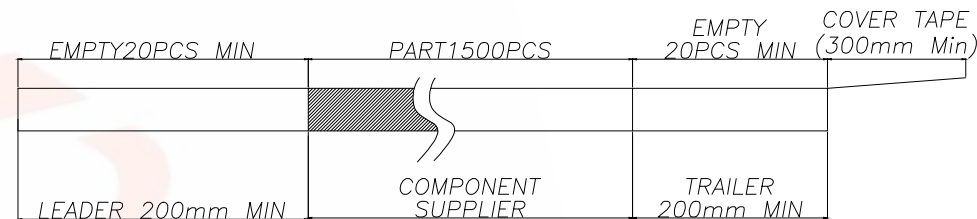
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN

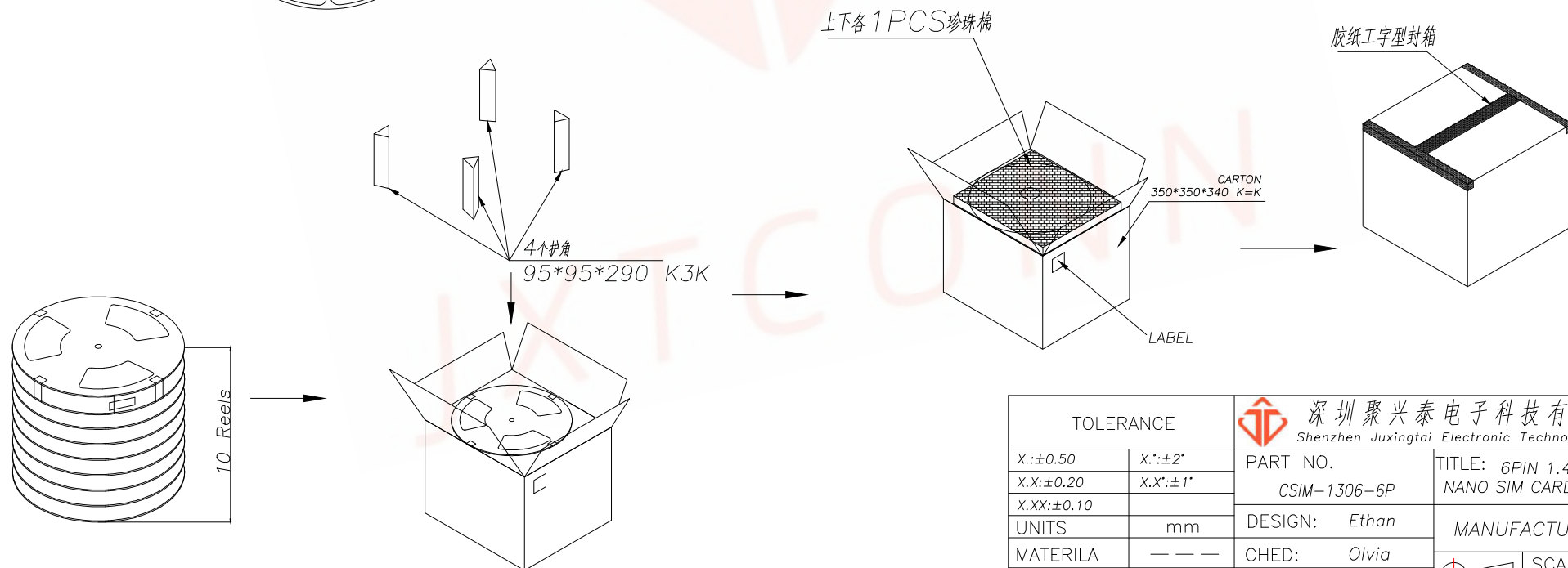


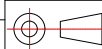
NOTES

1. NUMBER OF CONNECTORS:1500PCS/REEL
2. LEAD TAPE LENGTH



3. QUANTITY:15000PCS/CARTON



TOLERANCE		 深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd		
X.:±0.50	X':±2'	PART NO. CSIM-1306-6P	TITLE: 6PIN 1.4H HINGE NANO SIM CARD CONN. 封装	
X.X:±0.20	X.X':±1'			
X.XX:±0.10				
UNITS	mm	DESIGN: Ethan	MANUFACTURE DWG	
MATERILA	---	CHED: Olvia		
FINISH	---	APPD: Ava		
			 SCALE N:A	SHEET 1/1